

CMOS Digital Integrated Circuits Silicon Monolithic

TC74VCX574FT

1. Functional Description

· Low-Voltage Octal D-Type Flip-Flop with 3.6-V Tolerant Inputs and Outputs

2. General

The TC74VCX574FT is a high performance CMOS octal D-type flip-flop which is guaranteed to operate from 1.2 V to 3.6 V. Designed for use in 1.5 V, 1.8 V, 2.5 V or 3.3 V systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

It is also designed with over voltage tolerant inputs and outputs up to 3.6 V.

This 8 bit D-type flip-flop is controlled by a clock input (CK) and an output enable input (\overline{OE}) . When the \overline{OE} input is high, the eight outputs are in a high impedance state.

All inputs are equipped with protection circuits against static discharge.

3. Features

- (1) Wide operating temperature range: $T_{opr} = -40$ to 125 °C (Note 1)
- (2) Low-voltage operation: $V_{CC} = 1.2$ to 3.6 V
- (3) High-speed operation: $t_{pd} = 4.2 \text{ ns (max)} (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$

$$t_{pd} = 4.8 \text{ ns (max)} (V_{CC} = 2.3 \text{ to } 2.7 \text{ V})$$

$$t_{pd} = 9.6 \text{ ns (max)} (V_{CC} = 1.65 \text{ to } 1.95 \text{ V})$$

$$t_{pd} = 19.2 \text{ ns (max) (V}_{CC} = 1.4 \text{ to } 1.6 \text{ V})$$

$$t_{pd} = 48.0 \text{ ns (max) (V}_{CC} = 1.2 \text{ V)}$$

(4) Output current: $I_{OH}/I_{OL} = \pm 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$

$$I_{OH}/I_{OL} = \pm 18 \text{ mA (min) (V}_{CC} = 2.3 \text{ V)}$$

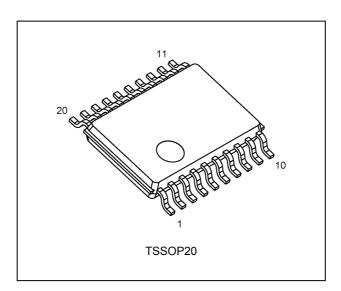
$$I_{OH}/I_{OL} = \pm 6 \text{ mA (min) (V}_{CC} = 1.65 \text{ V)}$$

$$I_{OH}/I_{OL} = \pm 2 \text{ mA (min) (V}_{CC} = 1.4 \text{ V)}$$

(5) 3.6 V tolerant function and power-down protection provided on all inputs and outputs.

Note 1: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2020.

4. Packaging

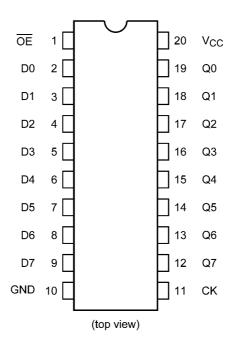


Start of commercial production

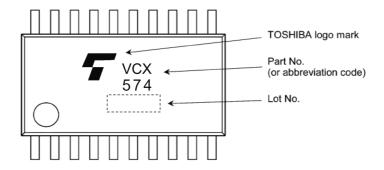
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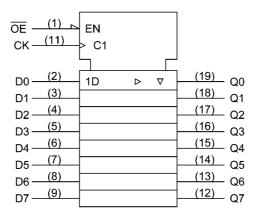
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



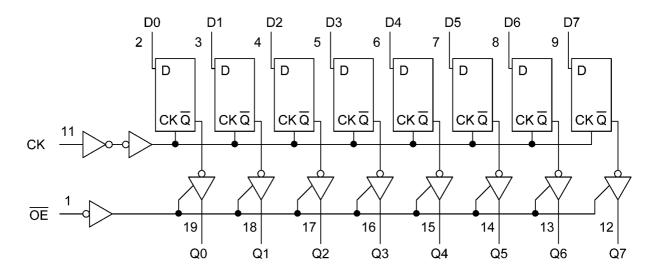


8. Truth Table

	Inputs		Outputs
ŌĒ	СК	D	Outputs
Н	Х	Х	Z
L	—	Х	Qn
L		L	L
L		Н	Н

X: Don't careZ: High impedanceQn: No change

9. System Diagram





10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 4.6	V
Input voltage	V _{IN}		-0.5 to 4.6	V
Output voltage	V _{OUT}	(Note 1)	-0.5 to 4.6	V
		(Note 2)	-0.5 to V _{CC} + 0.5	
Input diode current	I _{IK}		-50	mA
Output diode current	I _{OK}	(Note 3)	±50	mA
Output current	I _{OUT}		±50	mA
Power dissipation	P _D	(Note 4)	180	mW
V _{CC} /ground current	I _{CC} /I _{GND}		±100	mA
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Output in OFF state.

Note 2: High (H) or Low (L) state. IOUT absolute maximum rating must be observed.

Note 3: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$

Note 4: 180 mW in the range of T_a = -40 to 85 °C. From T_a = 85 to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

11. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		1.2 to 3.6	V
Input voltage	V_{IN}		-0.3 to 3.6	V
Output voltage	V _{OUT}	(Note 1)	0 to 3.6	V
		(Note 2)	0 to V _{CC}	
Output current	I_{OH},I_{OL}	(Note 3)	±24	mA
		(Note 4)	±18	
		(Note 5)	±6	
		(Note 6)	±2	
Operating temperature	T_{opr}	(Note 7)	-40 to 125	°C
Input rise and fall times	dt/dv	(Note 8)	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Note 1: Output in OFF state.

Note 2: High (H) or Low (L) state.

Note 3: V_{CC} = 3.0 to 3.6 V

Note 4: V_{CC} = 2.3 to 2.7 V

Note 5: V_{CC} = 1.65 to 1.95 V

Note 6: $V_{CC} = 1.4 \text{ to } 1.6 \text{ V}$

Note 7: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2020.

Note 8: V_{IN} =0.8 to 2.0 V , V_{CC} = 3.0 V



12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		1.2 to 1.4	$V_{CC} \times 0.8$	_	V
				1.4 to 1.65	$V_{CC} \times 0.65$	_	
				1.65 to 2.3	$V_{CC} \times 0.65$	_	
				2.3 to 2.7	1.6	_	
				2.7 to 3.6	2.0	_	
Low-level input voltage	V _{IL}	_		1.2 to 1.4	_	$V_{CC} \times 0.05$	V
				1.4 to 1.65	_	V _{CC} × 0.05	
				1.65 to 2.3	_	V _{CC} × 0.2	
				2.3 to 2.7	_	0.7	
				2.7 to 3.6	_	0.8	
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -100 μA	1.2	V _{CC} - 0.1	_	V
				1.4 to 1.65	V _{CC} - 0.2	_	
				1.65 to 3.6	V _{CC} - 0.2	_	
			I _{OH} = -2 mA	1.4	1.05	_	
			I _{OH} = -6 mA	1.65	1.25	_	
				2.3	2.0	_	
			I _{OH} = -12 mA	2.3	1.8	_	
				2.7	2.2	_	
			I _{OH} = -18 mA	2.3	1.7	_	
				3.0	2.4	_	
			I _{OH} = -24 mA	3.0	2.2	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.2	_	0.05	V
				1.4 to 1.65	_	0.05	
				1.65 to 3.6	_	0.2	
			I _{OL} = 2 mA	1.4	_	0.35	
			I _{OL} = 6 mA	1.65	_	0.3	
			I _{OL} = 12 mA	2.3	_	0.4	
				2.7	_	0.4	
			I _{OL} = 18 mA	2.3	_	0.6	
				3.0	_	0.4	
			I _{OL} = 24 mA	3.0	_	0.55	
Input leakage current	I _{IN}	V _{IN} = 0 to 3.6 V		1.2 to 3.6	_	±5.0	μΑ
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH}$ or V_{IL} $V_{OUT} = 0$ to 3.6 V		1.2 to 3.6	_	±10.0	μА
Power-OFF leakage current	I _{OFF}	$V_{IN}/V_{OUT} = 0$ to 3.6 V		0	_	10.0	μА
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		1.2 to 3.6	_	20.0	μА
		$V_{CC} \le (V_{IN}/V_{OUT}) \le 3.6 \text{ V}$		1.2 to 3.6	_	±20.0	
	Δl _{CC}	V _{IH} = V _{CC} - 0.6 V (per input)		2.7 to 3.6	_	750	μА

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12.2. DC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Condition	า	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		1.2 to 1.4	$V_{CC} \times 0.8$	_	V
				1.4 to 1.65	$V_{CC} \times 0.65$	_	
				1.65 to 2.3	V _{CC} × 0.65	_	
				2.3 to 2.7	1.6	_	
				2.7 to 3.6	2.0	_	
Low-level input voltage	V _{IL}	_		1.2 to 1.4	_	V _{CC} × 0.05	V
				1.4 to 1.65	_	$V_{CC} \times 0.05$	
				1.65 to 2.3	_	$V_{CC} \times 0.2$	
				2.3 to 2.7	_	0.7	
				2.7 to 3.6	_	0.8	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	1.2	V _{CC} - 0.1	_	V
				1.4 to 1.65	V _{CC} - 0.2	_	
				1.65 to 3.6	V _{CC} - 0.2	_	
			I _{OH} = -2 mA	1.4	1.05	_	
			I _{OH} = -6 mA	1.65	1.25	_	
				2.3	2.0	_	
			I _{OH} = -12 mA	2.3	1.8	_	
				2.7	2.2	_	
			I _{OH} = -18 mA	2.3	1.6	_	
				3.0	2.4	_	
			I _{OH} = -24 mA	3.0	2.2	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.2	_	0.05	V
				1.4 to 1.65	_	0.05	
				1.65 to 3.6		0.2	
			I _{OL} = 2 mA	11.4	_	0.35	
			I _{OL} = 6 mA	1.65	_	0.3	
			I _{OL} = 12 mA	2.3	_	0.4	
				2.7	_	0.4	
			I _{OL} = 18 mA	2.3	_	0.8	
				3.0	_	0.4	
			I _{OL} = 24 mA	3.0	_	0.55	
Input leakage current	I _{IN}	V _{IN} = 0 to 3.6 V		1.2 to 3.6	_	±20.0	μА
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 3.6 \text{ V}$		1.2 to 3.6	_	±40.0	μА
Power-OFF leakage current	I _{OFF}	$V_{IN}/V_{OUT} = 0$ to 3.6 V		0	_	40.0	μΑ
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		1.2 to 3.6		80.0	μΑ
		$V_{CC} \le (V_{IN}/V_{OUT}) \le 3.6 \text{ V}$		1.2to 3.6		±80.0	
	Δl _{CC}	$V_{IH} = V_{CC} - 0.6 V$ (per input)		2.7 to 3.6	_	1.5	mA

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2020.



12.3. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Max	Unit
Maximum clock frequency	f _{MAX}		See 12.7 AC Test Circuit,	1.2	40	_	MHz
			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	1.5 ± 0.1	80	_	
			Table 12.0.1	1.8 ± 0.15	100	_	
				2.5 ± 0.2	200	_	
				3.3 ± 0.3	250	_	
Propagation delay time	t _{PLH} ,t _{PHL}		See 12.7 AC Test Circuit,	1.2	1.5	48.0	ns
(CK-Q)			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	1.5 ± 0.1	1.0	19.2	
			Table 12.0.1	1.8 ± 0.15	1.5	9.6	
				2.5 ± 0.2	0.8	4.8	
				3.3 ± 0.3	0.6	4.2	
3-state output enable time	t _{PZL} ,t _{PZH}		See 12.7 AC Test Circuit,	1.2	1.5	49.0	ns
			Table 12.7.1, Fig. 12.8.2, Table 12.8.1	1.5 ± 0.1	1.0	19.6	
			Table 12.0.1	1.8 ± 0.15	1.5	9.8	
				2.5 ± 0.2	0.8	5.5	
				3.3 ± 0.3	0.6	4.5	
3-state output disable time	t_{PLZ}, t_{PHZ}		See 12.7 AC Test Circuit,	1.2	1.5	32.5	ns
			Table 12.7.1, Fig. 12.8.2, Table 12.8.1	1.5 ± 0.1	1.0	13.0	
				1.8 ± 0.15	1.5	6.5	
				2.5 ± 0.2	0.8	3.6	
				3.3 ± 0.3	0.6	3.3	
Minimum pulse width	$t_{w(L)}, t_{w(H)}$		See 12.7 AC Test Circuit,	1.2	24.0	_	ns
(CK)			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	1.5 ± 0.1	8.0	_	
			Table 12.0.1	1.8 ± 0.15	4.0	_]
				2.5 ± 0.2	1.5	_	
				3.3 ± 0.3	1.5	_	
Minimum setup time	ts		See 12.7 AC Test Circuit,	1.2	20.0	_	ns
			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	1.5 ± 0.1	7.5	_	
			Table 12.0.1	1.8 ± 0.15	2.5	_	
				2.5 ± 0.2	1.5	_	
				3.3 ± 0.3	1.5	_	
Minimum hold time	t _h		See 12.7 AC Test Circuit,	1.2	8.0	_	ns
			Table 12.7.1, Fig. 12.8.1,	1.5 ± 0.5	3.0	_	
			Table 12.8.1	1.8 ± 0.15	1.0	_	1
				2.5 ± 0.2	1.0	_	
				3.3 ± 0.3	1.0	_]
Output skew	t _{osLH} ,t _{osHL}	(Note 1)	_	1.2	_	1.5	ns
				1.5 ± 0.1	_	1.5	
				1.8 ± 0.15	_	0.5	
				2.5 ± 0.2	_	0.5	
				3.3 ± 0.3	_	0.5	1 I

Note 1: Parameter guaranteed by design. $(t_{osLH} = |t_{PLH}m-t_{PLH}n|, t_{osHL} = |t_{PHL}m-t_{PHL}n|)$



12.4. AC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Max	Unit
Maximum clock frequency	f _{MAX}		See 12.7 AC Test Circuit,	1.2	30	_	MHz
			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	1.5 ± 0.1	70	_	
			Table 12.0.1	1.8 ± 0.15	80	_	
				2.5 ± 0.2	150	_	
				3.3 ± 0.3	200	_	
Propagation delay time	t _{PLH} ,t _{PHL}		See 12.7 AC Test Circuit,	1.2	1.5	63.0	ns
(CK-Q)			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	1.5 ± 0.1	1.0	24.4	
			Table 12.0.1	1.8 ± 0.15	1.5	11.4	
				2.5 ± 0.2	0.8	5.7	
				3.3 ± 0.3	0.6	5.0	
3-state output enable time	t_{PZL}, t_{PZH}		See 12.7 AC Test Circuit,	1.2	1.5	60.0	ns
			Table 12.7.1, Fig. 12.8.2, Table 12.8.1	1.5 ± 0.1	1.0	23.2	
			Table 12.6.1	1.8 ± 0.15	1.5	11.6	
				2.5 ± 0.2	0.8	6.5	
				3.3 ± 0.3	0.6	5.4	
3-state output disable time	t_{PLZ}, t_{PHZ}		See 12.7 AC Test Circuit,	1.2	1.5	41.5	ns
			Table 12.7.1, Fig. 12.8.2, Table 12.8.1	1.5 ± 0.1	1.0	15.6	
				1.8 ± 0.15	1.5	7.8	
				2.5 ± 0.2	0.8	4.4	
				3.3 ± 0.3	0.6	4.0	
Minimum pulse width	$t_{w(L)}, t_{w(H)}$		See 12.7 AC Test Circuit,	1.2	26.0	_	ns
(CK)	,,,,,	Table 12.7.1, Fig. 12.8.1,		1.5 ± 0.1	8.7	_	
			Table 12.8.1	1.8 ± 0.15	4.4	_	
				2.5 ± 0.2	1.7	_	
				3.3 ± 0.3	1.7	_	
Minimum setup time	t _s		See 12.7 AC Test Circuit,	1.2	21.0	_	ns
			Table 12.7.1, Fig. 12.8.1,	1.5 ± 0.1	7.9	_	
			Table 12.8.1	1.8 ± 0.15	2.7	_	
				2.5 ± 0.2	1.6	_	
				3.3 ± 0.3	1.6	_	
Minimum hold time	t _h		See 12.7 AC Test Circuit,	1.2	8.4	_	ns
			Table 12.7.1, Fig. 12.8.1,	1.5 ± 0.1	3.2	_	
			Table 12.8.1	1.8 ± 0.15	1.1	_	
				2.5 ± 0.2	1.1	_	
				3.3 ± 0.3	1.1	_	
Output skew	t _{osLH} ,t _{osHL}	(Note 1)	_	1.2	_	2.0	ns
				1.5 ± 0.1	_	2.0	
				1.8 ± 0.15	_	1.0	
				2.5 ± 0.2	_	1.0	
				3.3 ± 0.3	_	1.0	

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after April 2020.

Note 1: Parameter guaranteed by design. $(t_{osLH} = |t_{PLH}m-t_{PLH}n|, t_{osHL} = |t_{PHL}m-t_{PHL}n|)$



12.5. Dynamic Switching Characteristics (Note) (Unless otherwise specified, $T_a = 25^{\circ}C$, Input: $t_r = t_f = 2.0$ ns, $C_L = 30$ pF)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	0.25	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	0.6	
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	
Quiet output minimum dynamic V _{OL}	V _{OLV}	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	-0.25	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	-0.6	
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	-0.8	
Quiet output minimum dynamic V _{OH}	V _{OHV}	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	1.5	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	1.9	
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	2.2	

Note: Parameter guaranteed by design.

12.6. Capacitive Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}		_	1.8, 2.5, 3.3	6	pF
Output capacitance	C _{OUT}		_	1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	C _{PD}	(Note 1)	f _{IN} = 10 MHz	1.8, 2.5, 3.3	20	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation. $I_{CC}(opr) = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8 \text{ (per 1 gate)}$

12.7. AC Test Circuit

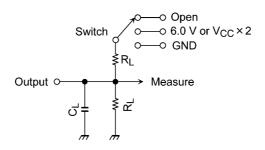


Table 12.7.1 Parameter for AC Test Circuit

Parameter	Switch	Test Condition
t _{PLH} , t _{PHL}	OPEN	_
t _{PLZ} , t _{PZL}	6.0 V	$V_{CC} = 3.3 \pm 0.3 \text{ V}$
	V _{CC} × 2	V_{CC} = 2.5 \pm 0.2 V
		V _{CC} = 1.8 ± 0.15 V
		V _{CC} = 1.5 ± 0.1 V
		V _{CC} = 1.2 V
t _{PHZ} , t _{PZH}	GND	_



12.8. AC Waveform

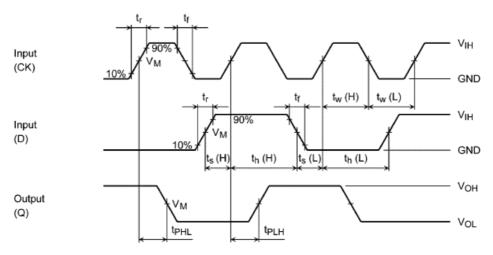


Fig. 12.8.1 t_{PLH} , t_{PHL} , t_w , t_s , t_h

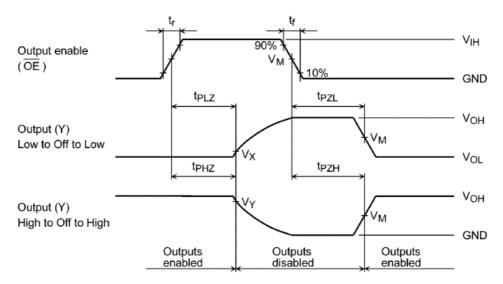


Fig. 12.8.2 t_{PLZ}, t_{PHZ}, t_{PZL}, t_{PZH}

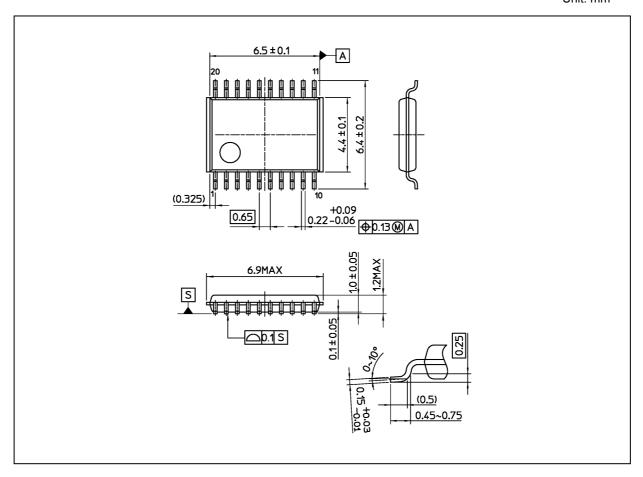
Table 12.8.1 AC Waveform Symbols

	Symbol	V_{CC} = 3.3 \pm 0.3 V	V_{CC} = 2.5 ± 0.2 V V_{CC} = 1.8 ± 0.15 V	$V_{CC} = 1.5 \pm 0.1 \text{ V}$ $V_{CC} = 1.2 \text{ V}$
Input	V _{IH}	2.7 V	V _{CC}	V _{CC}
	V_{M}	1.5 V	V _{CC} /2	V _{CC} /2
	t _r , t _f	2.0 ns	2.0 ns	2.0 ns
Output	V_{M}	1.5 V	V _{CC} /2	V _{CC} /2
	V _X	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V
	V_{Y}	V _{OH} - 0.3 V	V _{OH} - 0.15 V	V _{OH} - 0.15 V
Load	C _L	30 pF	30 pF	15 pF
	R_L	500 Ω	500 Ω	2 kΩ



Package Dimensions

Unit: mm



Weight: 0.08 g (typ.)

Package Name(s)
Nickname: TSSOP20



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